

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	WEIFENG BIAN	06/09/2020
	PAI RAJENDRA	06/09/2020
	TIAN XIA	06/09/2020
RECEIVING PARTY DATA		
Name:	TYCO ELECTRONICS (SHANGHAI) CO. LTD.	
Street Address:	SECTIONS F, G, H, LEVEL 1, BUILDING 15	
Internal Address:	NO. 999 YINGLUN ROAD, CHINA (SHANGHAI) PILOT FREE TRADE ZONE	
City:	SHANGHAI	
State/Country:	CHINA	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	16921130	
CORRESPONDENCE DATA		
Fax Number:	(610)889-3696	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	610-889-3699	
Email:	berwynipdocket@barley.com	
Correspondent Name:	BARLEY SNYDER	
Address Line 1:	2 GREAT VALLEY PARKWAY	
Address Line 2:	SUITE 110	
Address Line 4:	MALVERN, PENNSYLVANIA 19355	
ATTORNEY DOCKET NUMBER:	21334-3038	
NAME OF SUBMITTER:	SALVATORE ANASTASI	
SIGNATURE:	/Salvatore Anastasi/	
DATE SIGNED:	07/06/2020	
Total Attachments: 1		
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COMBINED DECLARATION AND ASSIGNMENT

As a below named and signing inventor, I hereby declare that:
this declaration is directed to inventions and improvements disclosed in:

- ☒ the attached application, or
☐ United States application or PCT international application number _____ filed on _____,

entitled **ELECTRICAL CONNECTION ASSEMBLY AND ELECTRICAL APPARATUS** ("the
APPLICATION");

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001
by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the
APPLICATION to:

Tyco Electronics (Shanghai) Co., Ltd. ("ASSIGNEE"), a corporation organized and existing under and by
virtue of the laws of China having its principal place of business at F/G/H Section, 1/F, Building 15, 999 Yinglun Road,
Pilot Free Trade Zone, Shanghai, China 201208,

for a valuable consideration, the receipt of which is hereby acknowledged, I do hereby sell, assign, transfer, and set
over unto the said ASSIGNEE, its successors and assigns, my full and entire right, title and interest in and to the
APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations,
continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the
United States of America, its territories and possessions, but also for, to and in all other countries, including all priority
rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof; and I hereby
authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters
Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment.

Legal Name	Signature	Date
Weifeng Bian	<i>Weifeng Bian</i>	06/09/2020
Pai Rajendra	<i>Pai Rajendra</i>	06/09/2020
Tian Xia	<i>Tian Xia</i>	06/09/2020